

*Preliminary Specifications Subject to Change without Notice*

### DESCRIPTION

The JW<sup>®</sup>5520S is a synchronous high-efficiency, boost converter with true output disconnection. The device adopts constant-off-time (COT) control topology.

The device can start up from an input voltage as low as 1.2V. The input switch peak current can be programmable up to 9A and the output average load current limit can be programmable by external resistors.

The typical operation frequency of JW5520S is 600kHz, which allows smaller inductor and capacitors to achieve a small solution size.

During light load condition, PFM is engaged to maintain the maximum efficiency.

JW5520S guarantees robustness with output short circuit protection and thermal shutdown.

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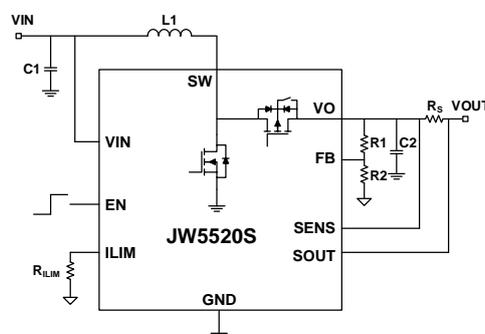
### FEATURES

- 1.2V Minimum Start-up Input Voltage
- 1.2V to 5.5V Input Voltage Range
- 2.5V to 5.5V Output Voltage Range
- Support 5V/3.5A Output from 2.8V Input
- Up to 9A Programmable Switch Peak Current Limit
- Programmable Average Load Current Limit
- 600kHz Pseudo-Constant Frequency Switching
- Low Quiescent Current: <40uA
- High Efficiency over Full Load Range
- True Output Disconnection from Input
- Thermal Shutdown and Output Short Circuit Protection
- Package: QFN2x2-14

### APPLICATIONS

- Battery Powered Systems
- Power Banks, Juice Packs, Battery Back-Up
- Electronic Cigarettes
- Consumer Electronic Accessories
- USB Power Supplies

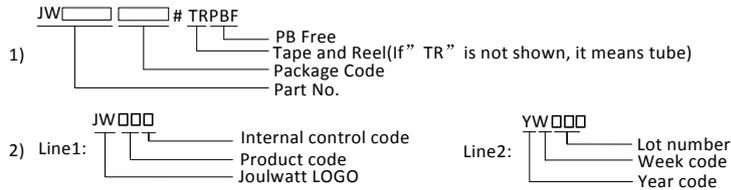
### TYPICAL APPLICATION



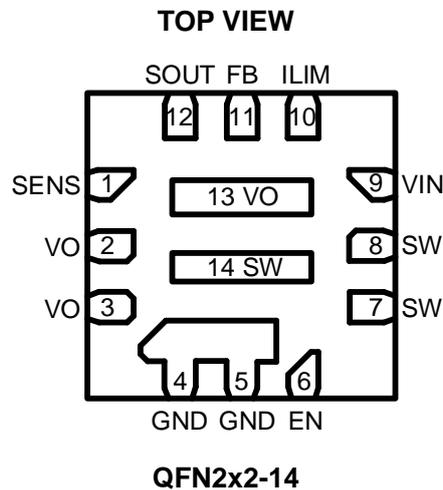
**ORDER INFORMATION**

DEVICE <sup>1)</sup>	PACKAGE	TOP MARKING <sup>2)</sup>
JW5520SQFNAE#TRPBF	QFN2X2-14	JWFA□ YW□□□

**Notes:**



**PIN CONFIGURATION**



**ABSOLUTE MAXIMUM RATING<sup>1)</sup>**

All Pins .....	-0.3V to 6.5V
Junction Temperature <sup>2)</sup> .....	150°C
Lead Temperature .....	260°C
Storage Temperature .....	-65°C to +150°C

**ESD Ratings**

Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>3)</sup> .....	±2000V
Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>4)</sup> .....	±500V

**RECOMMENDED OPERATING CONDITIONS<sup>5)</sup>**

Input Voltage VIN .....	1.2V to 5.5V
Operation Junction Temperature (T <sub>J</sub> ) .....	-40°C to +125°C

Ambient Temperature Range ..... -40°C to +85°C

**THERMAL PERFORMANCE<sup>6)</sup>** $\theta_{JA}$     $\theta_{JC}$ 

QFN2x2-14..... 80...16°C/W

**Note:**

- 1) Exceeding these ratings may damage the device. These stress ratings do not imply function operation of the device at any other conditions beyond those indicated under RECOMMEND OPERATION CONDITIONS.
- 2) The JW5520S includes thermal protection that is intended to protect the device in overload conditions. Continuous operation over the specified absolute maximum operating junction temperature may damage the device.
- 3) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500 V HBM is possible with the necessary precautions. Pins listed as  $\pm 2000$  V may actually have higher performance.
- 4) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250 V CDM is possible with the necessary precautions. Pins listed as  $\pm 500$  V may actually have higher performance.
- 5) The device is not guaranteed to function outside of its operating conditions.
- 6) Measured on JESD51-7, 4-layer PCB.

**ELECTRICAL CHARACTERISTICS**

<i>V<sub>IN</sub></i> =3.3V, <i>T<sub>A</sub></i> =25°C, unless otherwise stated						
Item	Symbol	Condition	Min.	Typ.	Max.	Units
<b>General parameters</b>						
Input Voltage Range	V <sub>IN</sub>		1.2		5.5	V
VIN UVLO Threshold	V <sub>IN_UVLO</sub>	V <sub>IN</sub> rising		0.9		V
		V <sub>IN</sub> falling		0.65		V
EN Logic High Threshold <sup>5)</sup>	V <sub>EN_H</sub>	V <sub>IN</sub> ≤ 2.3V, EN rising		0.74		V
EN Logic High Threshold	V <sub>EN_H</sub>	V <sub>IN</sub> > 2.3V, EN rising		1.2	1.3	V
EN Logic Low Threshold <sup>5)</sup>	V <sub>EN_L</sub>	V <sub>IN</sub> ≤ 2.5V, EN falling	0.4	0.54		V
EN Logic Low Threshold	V <sub>EN_L</sub>	V <sub>IN</sub> > 2.5V, EN falling	0.4	1.08		V
EN Input Current	I <sub>EN</sub>	Connect to V <sub>IN</sub>			50	nA
Quiescent Current into VO pin	I <sub>Q</sub>	V <sub>EN</sub> = V <sub>IN</sub> = 3.3V, V <sub>O</sub> = 5V, V <sub>FB</sub> = 1.3V, no load			40	μA
Top Switch On-Resistance	R <sub>dsTG</sub>			14		mΩ
Bottom Switch On-Resistance	R <sub>dsBG</sub>			8		mΩ
Shutdown Current	I <sub>SD</sub>	V <sub>O</sub> = V <sub>EN</sub> = 0V			0.1	μA
Operation Frequency	F <sub>SW</sub>			600		kHz
Minimum ON time	T <sub>ON_MIN</sub>			200		ns
Feedback Voltage Reference	V <sub>FB</sub>			1200		mV
Feedback Input Current	I <sub>FB</sub>				50	nA
Switch Peak Current Limit	I <sub>SW_LIM</sub>			9		A
Output Current Limit	I <sub>OLIM</sub>	R <sub>s</sub> = 8mΩ		3.75		A
<b>Protection</b>						
Output OVP Threshold	V <sub>O_OVP</sub>	V <sub>O</sub> rising		6		V
		V <sub>O</sub> falling		5.5		
OCP Hiccup ON Time	T <sub>hiccup_on</sub>			10		ms
OCP Hiccup OFF Time	T <sub>hiccup_off</sub>			2		s
Thermal Shutdown Threshold <sup>5)</sup>	T <sub>SHUT</sub>			150		°C
Thermal Recovery Threshold <sup>5)</sup>	T <sub>REC</sub>			130		°C

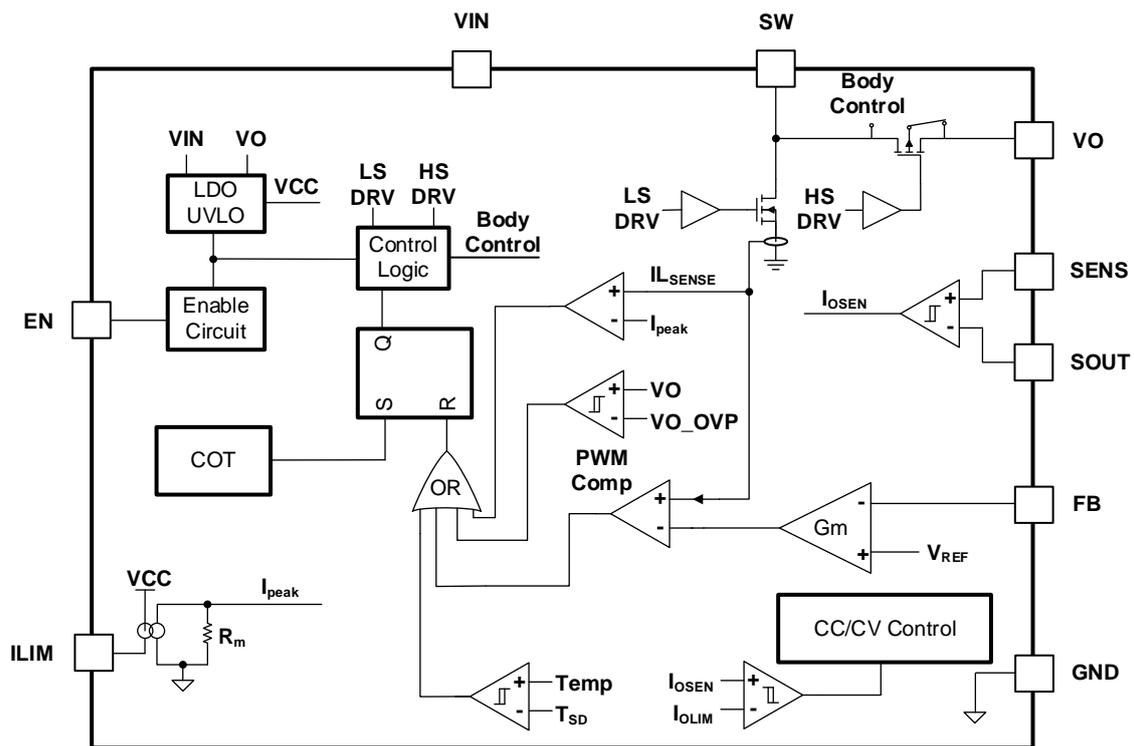
**Notes:**

5) Guaranteed by design.

**PIN DESCRIPTION**

Pin No.	Name	Description
1	SENS	Load Current Sense Pin. Connect a load sense resistor between this pin and SOUT pin to set the maximum load current.
2, 3, 13	VO	Output Pin.
4,5	GND	Power Ground.
6	EN	Chip Enable Control Input.
7, 8, 14	SW	Power Switch Output.
9	VIN	Power Supply Input.
10	ILIM	Switch Peak Current Limit Set Pin.
11	FB	Feedback Input to Error Amplifier. Connect resistor divider tap to this pin.
12	SOUT	Load Current Sense Pin. Connect a load sense resistor between this pin and SENS pin to set the maximum load current.

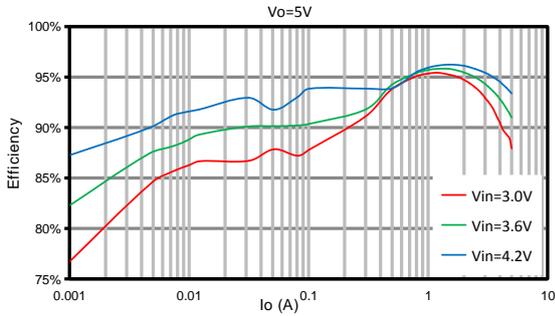
**BLOCK DIAGRAM**



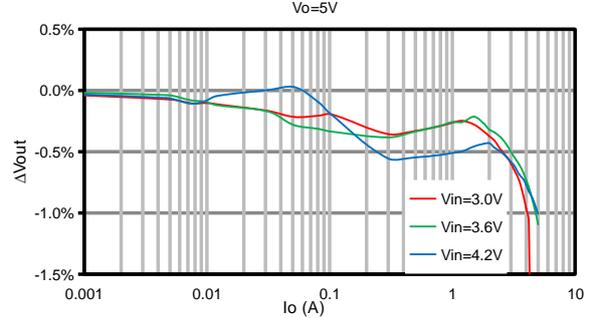
# TPICAL PERFORMANCE CHARACTERISTICS

$V_{IN}=1.2V\sim 4.8V$ ,  $V_O=5V$ ,  $L=1.5\mu H$ ,  $C_O=2\times 22\mu F+100nF$ ,  $T_A = +25^\circ C$ , unless otherwise noted

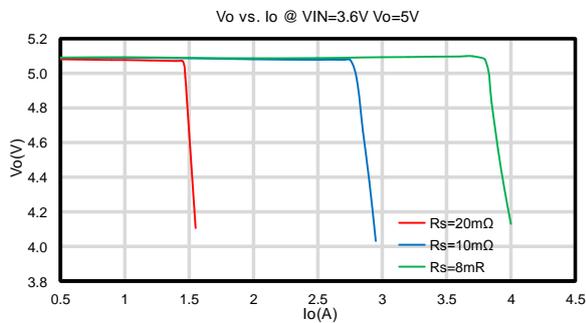
Efficiency vs. Load Current



$\Delta V_{out}$  vs. Load Current

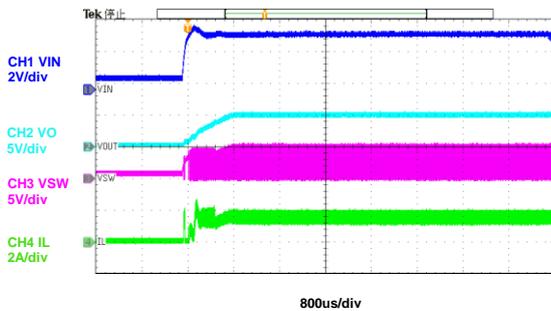


Output Current Limit  $V_{out}$  vs. Load Current



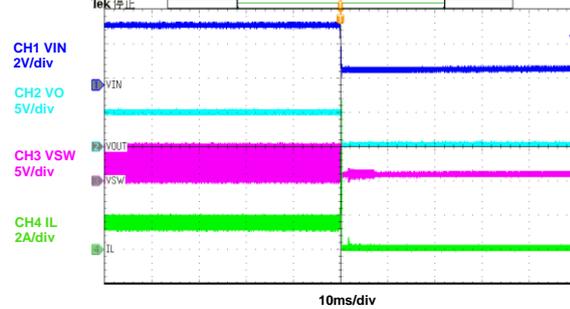
VIN Power On

$V_{IN}=3.6V$ ,  $V_O=5V$ ,  $I_O=1A$



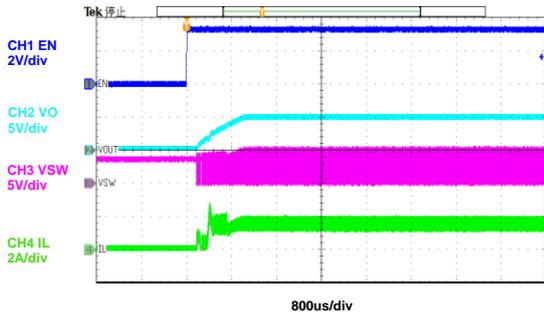
VIN Power off

$V_{IN}=3.6V$ ,  $V_O=5V$ ,  $I_O=1A$



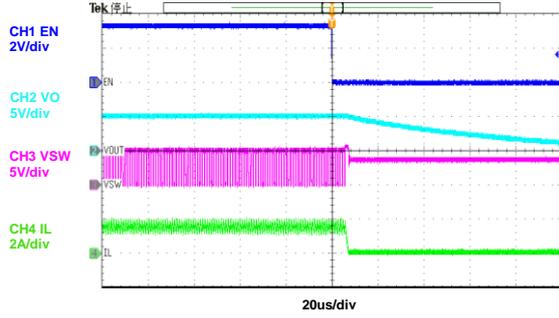
**EN Power On**

$V_{IN}=3.6V, V_O=5V, I_O=1A$



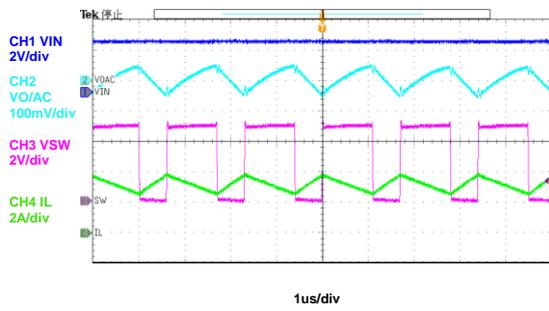
**EN Power off**

$V_{IN}=3.6V, V_O=5V, I_O=1A$



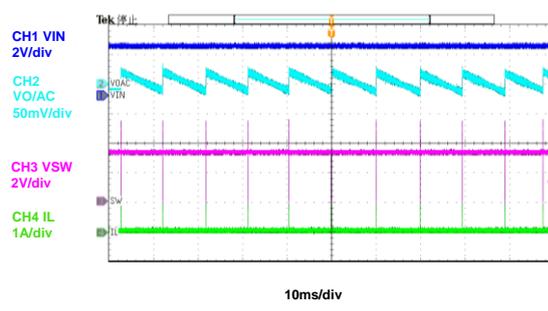
**Steady State**

$V_{IN}=3.3V, V_O=5V, I_O=2A$



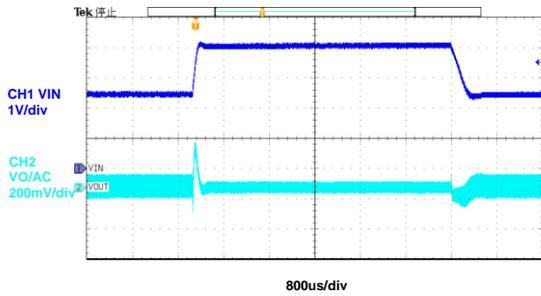
**Steady State**

$V_{IN}=3.3V, V_O=5V, I_O=0A$



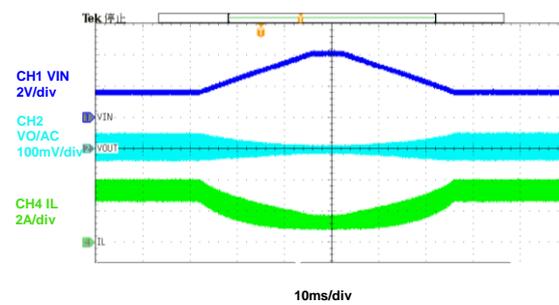
**Line Transient**

$V_{IN}=2.5V \rightarrow 4V \rightarrow 2.5V, V_O=5V, I_O=2A$



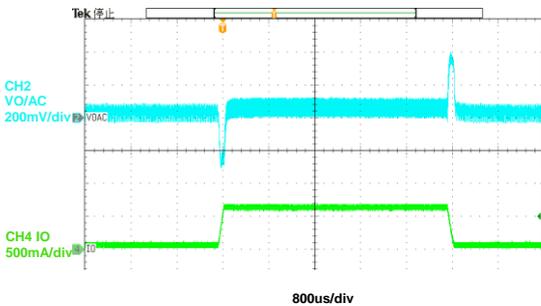
**Line Sweep**

$V_{IN}=1.6V \rightarrow 4V \rightarrow 1.6V, V_O=5V, I_O=1A$



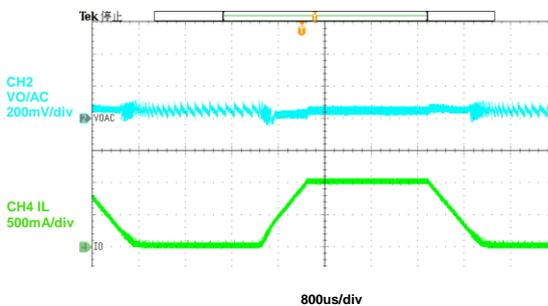
**Load Transient**

$V_{IN}=3.6V, V_O=5V, I_O=0.2A \rightarrow 2.5A \rightarrow 0.2A, I_{RAMP}=200mA/us$



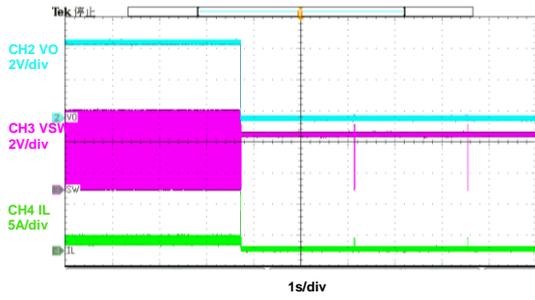
**Load Sweep**

$V_{IN}=3.6V, V_O=5V, I_O=0A \rightarrow 1A \rightarrow 0A, I_{RAMP}=1mA/us$



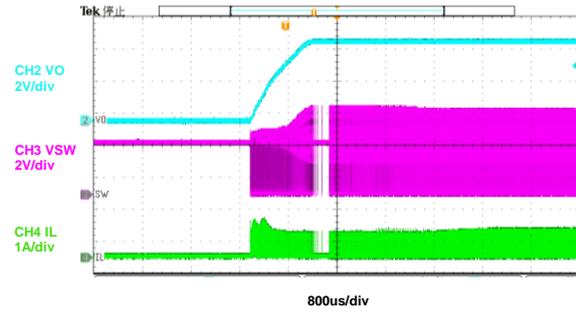
**Output Short Protection (Entry)**

$V_{IN}=3.6V, V_O=5V, I_O=1A \rightarrow$  Output Short



**Output Short Protection (Recover)**

$V_{IN}=3.6V, V_O=5V, \text{Output Short} \rightarrow I_O=0.5A$



## FUNCTIONAL DESCRIPTION

The JW5520S is a synchronous, high-efficiency, boost converter with true output disconnection. It is designed to operate from an input voltage range between 1.2V and 5.5V with up to 9A peak switch current limit. The output current limit can be programmable through external resistor.

PFM is engaged to maintain high efficiency at light load. In PFM mode, switching frequency is continuously controlled in proportion to the load current. Switch frequency decreases when load current drops to increase power efficiency at light load by reducing switching loss and minimizing the circuit power dissipation.

The JW5520S guarantees robustness with short-circuit protection and thermal shutdown.

### Start-Up

When the device is enabled, the JW5520S can start up from a voltage as low as 1.2V.

If the input voltage is lower than 2.2V, the JW5520S starts in pre-boost mode. During this phase, converter switches to build up the output voltage preliminarily and the switching frequency is controlled by an internal clock, which is not precise. Once the output voltage is above 2.2V, all the internal control circuit is powered up, and the converter enters normal boost mode, in which the JW5520S steps up the voltage to the setting value by following an internal ramp up reference voltage.

If the input voltage is higher than 2.2V, the JW5520S starts in down mode to build up the output voltage, during which the top switch body diode is reversed, and its gate is connected to VIN. Once the output voltage is higher than input voltage, the converter enters normal boost mode.

### Device Enable

The JW5520S starts operation when EN pin is pulled high and starts up with a soft-start process. Pulling EN pin low can force the device into shutdown mode with a current consumption of typically 0.1μA. In shutdown mode, the chip stops switching and all the internal control circuit is off, and the load is truly disconnected from the input.

### Output Disconnection

A true output disconnection between input and output is implemented in the device. This feature guarantees robustness with short-circuit protection to prevent the device from being damaged by inrush current. It can also limit the output current at start-up.

### Output Voltage

The output voltage is set by an external feedback resistive divider. The feedback signal is compared with internal precision 1.2V voltage reference by an error amplifier. The output voltage can be given by the equation:

$$V_O(V) = \frac{1.2V \times (R_1 + R_2)}{R_2}$$

Where  $R_1$  and  $R_2$  are defined in the typical application figure.

### Switch Peak Current Limit Setting

To prevent the device from being damaged by a large input peak current, a cycle-by-cycle current limit is adopted in JW5520S. The low side switch is turned off immediately, as soon as the switch current touches the setting limit, which is programmed by a resistor from the ILIM pin to ground. The peak current limit can be given by the formula below:

$$I_{peak} (A) = 9 - \frac{433}{R_{ILIM} (k\Omega)}$$

where  $I_{peak}$  is the switch peak current limit,  $R_{ILIM}$  is the resistor between ILIM pin and ground.

### Output Current Limit Setting

The JW5520S provides programmable limits of the output current. The SENS and SOUT pin should be configured as figure below:

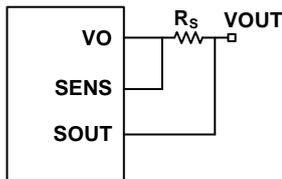


Figure 1. Output current limit setting

The SENS and SOUT pin should be tied to the both ends of the current sensing resistor. Then the limit current can be shown in the equation below:

$$I_{OLIM} (A) = \frac{30mV}{R_s (m\Omega)}$$

where  $I_{OLIM}$  is the setting output current limit,  $R_s$  is the current sensing resistor.

### Constant Output Current Control

When output current touches the setting output current limit, the converter turns down the output voltage to limit the output power. the output voltage can be seen in the figure 2.

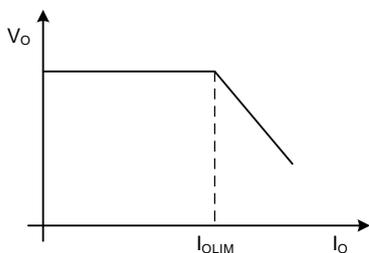


Figure 2. Constant Output Current Control

### Down Mode

When the  $V_{in}$  is higher than  $V_o - 200mV$ , the device works in down mode. In this mode, the top switch body diode is reversed, and the top switch gate is connected to  $V_{IN}$ . The top switch operates in linear mode to bleed the inductor current to avoid the inductor current run away and prevent the SW voltage overshoot. After entering downmode, when the  $V_{in}$  is lower than  $V_o - 250mV$ , the device returns boost mode. It is not recommended to operate the JW5520S in down mode for normal work, unless the system performance will not be affected by the temperature rise.

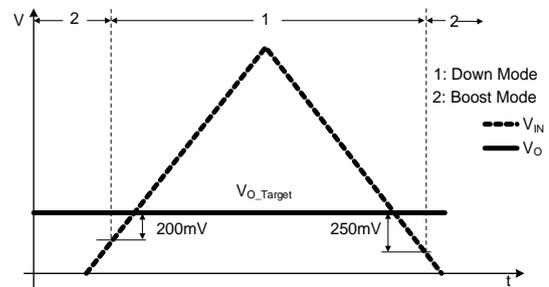


Figure 3. Down Mode and Boost Mode Operation

### Thermal Regulation Control

If the junction temperature is higher than  $130^{\circ}C$ , the device begins to reduce the output voltage in order to prevent the junction temperature from rising further, when the junction temperature rises to  $150^{\circ}C$ , the device shuts down.

### Protection

#### Over Load and Short Circuit Protection

If the output current touches output current limit, the output current loop begins to work, it decreases output voltage to limit the output power. When the output voltage is less than  $0.4V$ , the peak current is limited to approximate  $1 A$ . For about  $10 ms$ , the device shuts down.

After the delay time  $T_{\text{hiccup\_off}}$  (typ.2 s), the device attempts to start up again.

Short circuit protection is only valid when the input voltage is below 5.0 V. If the input voltage is higher than 5.0V, a long term short to ground event may damage the device.

### **Over Voltage Protection**

If output voltage is higher than 6V, the device stops switching. Until the output voltage drops below 5.5V, the device resumes switching automatically.

### **Thermal Shutdown**

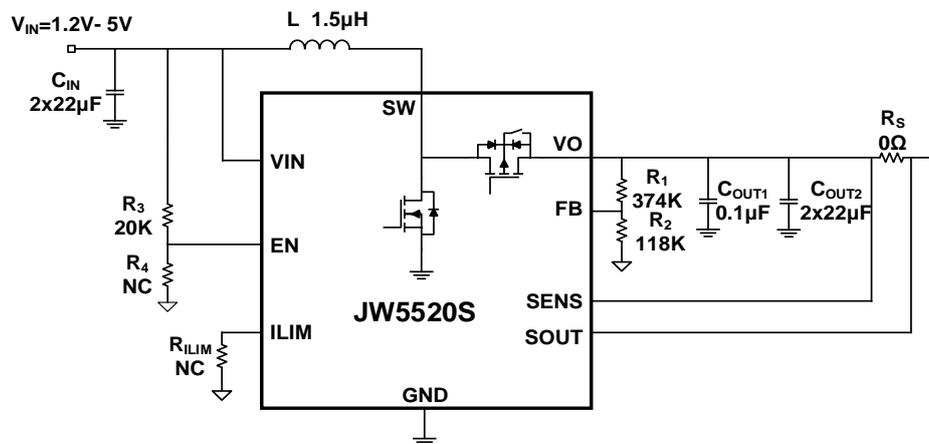
When the junction temperature of the device rises above  $T_{\text{SHUT}}$ , the device is forced into shut down mode. When the temperature drops below  $T_{\text{REC}}$ , the device can be resumed with soft start.

**APPLICATION INFORMATION**

The JW5520S is designed to operate from an input voltage supply range between 1.2V and 5.5V with true output disconnection. The input switch peak current can be programmable up to 9A and the output average load current limit can be programmable by external resistors. The JW5520S operates at a quasi-constant

frequency pulse-width modulation (PWM) in moderate to heavy load condition, and the switching frequency is fixed at 600kHz. In light load condition, the converter can operate in the PFM mode to achieve high efficiency over the entire load current range.

**Typical Application Circuit**



**Design Requirements**

**Table 1. Design Parameters**

DESIGN PARAMENTERS	EXAMPLES VALUES
Input voltage range	1.2V ~ 4.8V
Output voltage	5.0V
Output current limit	No
Switch peak current limit	9A

**Setting the Output Voltage**

The external resistor divider is used to set the output voltage. Typically, choose R<sub>1</sub> to be between 300kΩ - 800kΩ. Then calculate R<sub>2</sub> with the equation listed below:

$$R_2(k\Omega) = \frac{V_{REF}}{V_{OUT} - V_{REF}} \times R_1(k\Omega)$$

Where V<sub>REF</sub> is 1.2V, R<sub>1</sub> is the top feedback resistor, an R<sub>2</sub> is the bottom feedback resistor.

**Selecting the Input Capacitor**

The input capacitor (C<sub>IN</sub>) is used to maintain the DC input voltage. Low ESR ceramic capacitors are recommended. The input voltage ripple can be estimated with the following equation:

$$\Delta V_{IN}(V) = \frac{V_{IN}}{8 \cdot f_{SW}^2 \cdot L \cdot C_{IN}} \times (1 - \frac{V_{IN-}}{V_{OUT}})$$

Where f<sub>SW</sub> is the switching frequency, and L is the inductor value.

**Selecting the Output Capacitor**

The output current of the boost converter is discontinuous and therefore requires an output capacitor (C<sub>OUT</sub>) to supply AC current to the load. For the best performance, low ESR ceramic capacitors are recommended. The output voltage ripple can be estimated with the equation listed below:

$$\Delta V_{OUT}(V) = \frac{V_{OUT}}{f_s \cdot R_L \cdot C_{OUT}} \times (1 - \frac{V_{IN-}}{V_{OUT}})$$

Where R<sub>L</sub> is the value of the load resistor. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low

ESR and small temperature coefficients.

**Selecting the Inductor**

An inductor is required to transfer the energy between the input source and the output capacitors. An inductor with a larger value results in less ripple current and a lower peak inductor current, reducing stress on the power MOSFET. However, the larger value inductor has a larger physical size, a higher series resistance, and a lower saturation current. For the smaller value inductor, larger current ripple generates higher DCR and ESR conduction losses and higher core loss. Usually, a data sheet of an inductor does not provide the ESR and core loss information. If needed, consult the inductor vendor for detailed information.

For most designs, the inductance value can be calculated with the following equation:

$$L = \frac{V_{IN}(V_{OUT} - V_{IN-})}{f_s \cdot V_{OUT} \cdot \Delta I_L}$$

Where ΔI<sub>L</sub> is the inductor ripple current. Choose the inductor ripple current to be approximately 20% ~ 50% of the maximum inductor peak current. Ensure that the inductor does not saturate under the worst-case condition. The inductor should have a low series resistance (DCR<10mΩ) to reduce the resistive power loss. The following table lists recommended inductors for this example application.

Table 2. Recommended Inductors for the example application

PART NUMBER	L (μH)	DCR MAX (mΩ)	SATURATION CURRENT (A)	SIZE MAX (L x W x H: mm)	VENDOR
74437349015	1.5	8.6	14.5	7.3 x 6.6 x 4.8	Wurth
SPM6550T-1R5M-HZ	1.5	6.49	10.3	7.1 x 6.5 x 5.0	TDK

**Switching Peak Current Limit Setting**

The ILIM resistor (R<sub>ILIM</sub>) is used to set the inductor switching peak current limit. Calculate R<sub>ILIM</sub> with the following equation:

$$R_{ILIM}(k\Omega) = \frac{433}{9 - I_{peak}(A)}$$

For example, if the required peak current limit is 8A, then R<sub>ILIM</sub> is 433kΩ.

**Output Current Limit Setting**

The resistor (R<sub>s</sub>) is used to set the output current limit. Calculate R<sub>s</sub> with the following equation:

$$R_s(m\Omega) = \frac{30mV}{I_{OLIM}(A)}$$

For example, if the output current limit is 3A, then R<sub>s</sub> is 10mΩ.

**PCB Layout Guidelines**

Efficient PCB layout is critical for high-frequency switching power supplies. A poor layout can result in reduced performance, excessive EMI, resistive loss, and system instability. For best results, refer to the following figure and follow the guidelines below.

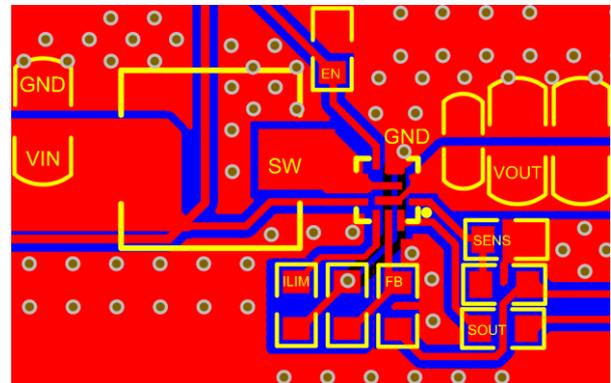
1. Place the output capacitor (C<sub>OUT2</sub>) as close to VO and GND as possible, Place a 0.1uF

capacitor (C<sub>OUT1</sub>) close to the IC to reduce the PCB parasitical inductance.

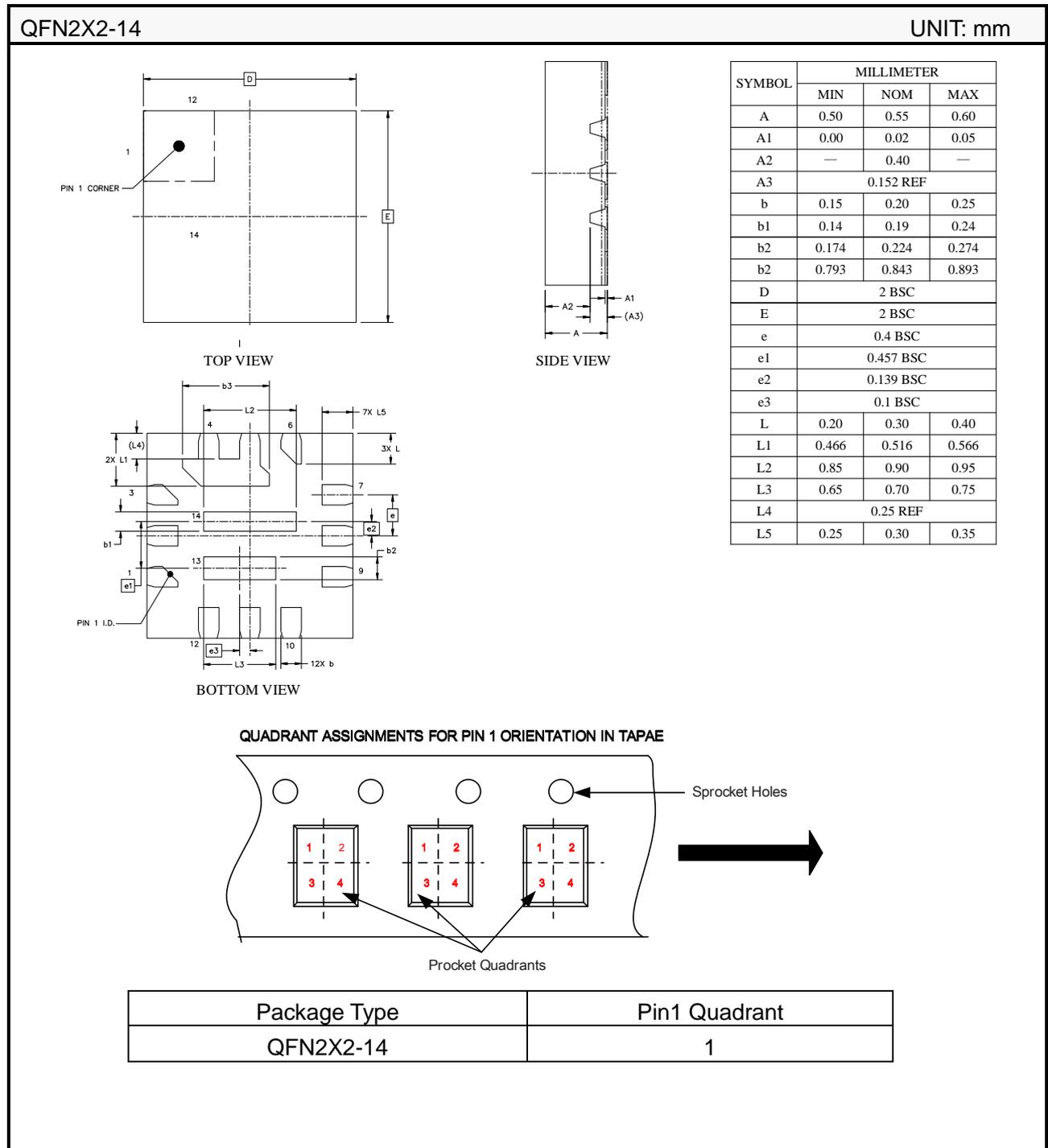
2. Keep the connection of VO and GND to the output capacitor short and wide with copper.
3. Place the FB divider R<sub>1</sub> and R<sub>2</sub> as close to FB as possible.
4. Keep the FB trace far away from noise source, such as the SW node (switching node).
5. Place the current limit setting net (R<sub>ILIM</sub>) close to ILIM pin.
6. Keep the input loop (C<sub>IN</sub>,L,SW pin and GND) as small as possible.
7. Place enough GND vias close to the JW5520S for good thermal dissipation.

**Layout Example**

The layout example shows as the follow figures.



PACKAGE OUTLINE



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